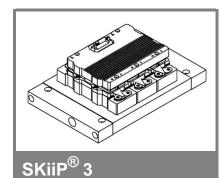
SKiiP 1803GB172-3DW



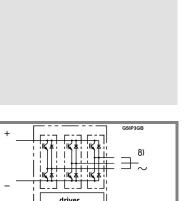
2-pack-integrated intelligent Power System

Power section SKiiP 1803GB172-3DW

Data

Power section features

- · SKiiP technology inside
- Trench IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated teperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- 1) with assembly of suitable MKP capacitor per terminal
- 8) AC connection busbars must be connected by the user; copper busbars available on request



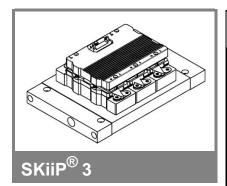
Absolute	Maximum Ratings	s = 25°C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V _{CES} V _{CC} 1)	Operating DC link voltage	1700 1200	V V			
V_{GES}		± 20	V			
I _C	T _s = 25 (70) °C	1800 (1350)	Α			
Inverse diode						
$I_F = -I_C$	T _s = 25 (70) °C	1400 (1050)	Α			
I _{FSM}	$T_j = 150 ^{\circ}\text{C}, t_p = 10 \text{ms}; \text{sin}$	10200	Α			
I ² t (Diode)	Diode, T _j = 150 °C, 10 ms	520	kA²s			
T _j , (T _{stg})		- 40 + 150 (125)	°C			
V _{isol}	rms, AC, 1 min, main terminals to heat sink	4000	V			
I _{AC-terminal}	per AC terminal, rms, T _s = 70 °C,	400	Α			
	T _{terminal} <115 °C					

- Characteristics					T _s = 25°C unless otherwise specified				
Symbol	Conditions			min.	typ.	max.	Units		
IGBT									
V _{CEsat}	I _C = 900 A measured at to	, T _j = 25 ([*] erminal	125) °C;			1,9 (2,2)	2,4	V	
V_{CEO}	T _i = 25 (12	25) °C; at t	erminal			1 (0,9)	1,2 (1,1)	V	
r _{CE}	$T_i = 25 (12)$					1 (1,4)	1,3 (1,7)	mΩ	
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES} , T _i = 25 (125) °C				mA				
$E_{on} + E_{off}$	$I_{C}^{J} = 900 \text{ A}, V_{CC} = 900 \text{ V}$ $T_{j} = 125 ^{\circ}\text{C}, V_{CC} = 1200 \text{ V}$				mJ				
					mJ				
R _{CC+EE} ,	terminal chip, T _i = 25 °C					mΩ			
L _{CE}	top, botton	n ´				4		nΗ	
C _{CHC}	per phase,	AC-side				3		nF	
Inverse o	diode								
$V_F = V_{EC}$	I _F = 900 A, measured at to	, T _j = 25 (1 erminal	125) °C			2 (1,8)	2,15	V	
V_{TO}	T _i = 25 (12	25) °C				1,1 (0,8)	1,2 (0,9)	V	
r _T	$T_i = 25 (12)$	25) °C				1 (1,1)	1,1 (1,2)	mΩ	
E _{rr}	$I_{\rm C} = 900 {\rm A}$, V _{CC} = 90	00 V			108		mJ	
	T _j = 125 °C	C, V _{CC} = 1	200 V			128		mJ	
Mechani	cal data							•	
M _{dc}	DC termina	als, SI Uni	ts		6		8	Nm	
M _{ac}	AC termina				13		15	Nm	
w	SKiiP® 3 System w/o heat sink					2,4		kg	
w	heat sink					5,2		kg	
						c);			
		e to bui	It-in ten	nperature	sensor	(acc.IEC			
$R_{th(j-s)I}$	per IGBT						0,017	K/W	
R _{th(j-s)D}	per diode						0,033	K/W	
Z_{th}	R _i (mK/W) (max. values)					tau			
	1	2	3	4	1	2	3	4	
$Z_{\text{th(j-r)I}}$	1,4	6,8	7,8	0	69	0,35	0,02	1	
Z _{th(j-r)D}	2,6	4	17,7	17,7	50	5	0,25	0,04	
$Z_{th(r-a)}$	4,6	4,7	1,1	0,6	48	15	2,8	0,4	

^{*} The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

Case S33

SKiiP 1803GB172-3DW



2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1803GB172-3DW

Data

Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings	= 25°C unless otherwise specified		
Symbol	Conditions	Values	Units	
V_{S2}	unstabilized 24 V power supply	30	V	
V_{i}	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
V_{isollO}	input / output (AC, rms, 2s)	4000	V	
V _{isoIPD}	partial discharge extinction voltage, rms, Q _{PD} ≤10 pC;	1500	V	
V _{isol12}	output 1 / output 2 (AC, rms, 2s)	1500	V	
f _{sw}	switching frequency	9	kHz	
f _{out}	output frequency for I _{peak(1)} =I _C	9	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C	

Characte	eristics	(T _a = 25°0			= 25°C)
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	380+34*f/kHz+0,00015*(I _{AC} /A) ²			mA
V _{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
$t_{d(off)IO}$	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time		9		μs
t_{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5mA; 8 V corresponds to 15 V supply voltage for external components		1500		Α
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level				
	(I _{analog} OUT = 10 V)		1875		Α
T_tp	over temperature protection	110		120	°C
U _{DCTRIP}	U_{DC} -protection ($U_{analog OUT} = 9 V$);		not implemented	l	V
	(option for GB types)				

For electrical and thermal design support please use SEMISEL. Access to SEMISEL is via SEMIKRON website http://www.semikron.com.

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